

• Product Summary

Part #	V _{DS}	R _{DS(on).typ} (@V _{GS} =10V)	R _{DS(on).typ} (@V _{GS} =4.5V)	I _D
EFM3403A	-30V	88mΩ	103mΩ	-2.6A

• Features

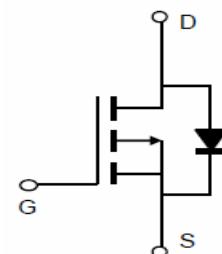
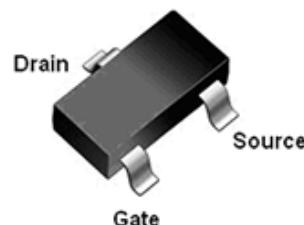
- Low R_{DS(on)} @ V_{GS}=-10V
- -4.5V Logic Level Control
- P Channel SOT23-3L Package
- Pb-Free, RoHS Compliant

• Application

- High-side Load Switch
- Switching Circuits
- High Speed line Driver

• Ordering Information:

Part NO.	EFM3403A
Marking	A3***
Packing Information	REEL TAPE
Basic ordering unit (pcs)	3000


P-Channel MOSFET

HF
• Absolute Maximum Ratings (T_C=25°C)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	-30	V
Gate-Source Voltage	V _{GS}	±12	V
Drain Current-Continuous	I _D	-2.6	A
Drain Current-Pulsed (Note 1)	I _{DM}	-13	A
Maximum Power Dissipation	P _D	1.4	W
Operating Junction and Storage Temperature Range	T _J , T _{STG}	-55 To 150	°C

• Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	R _{θJA}	125	°C/W
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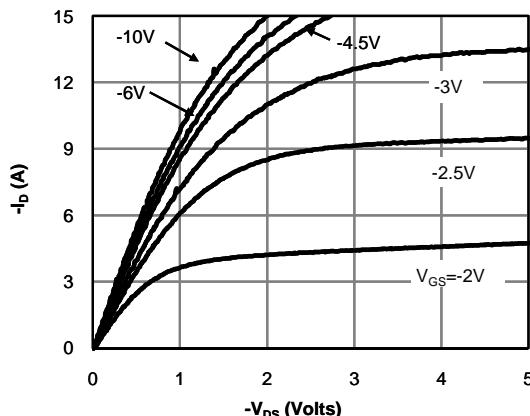
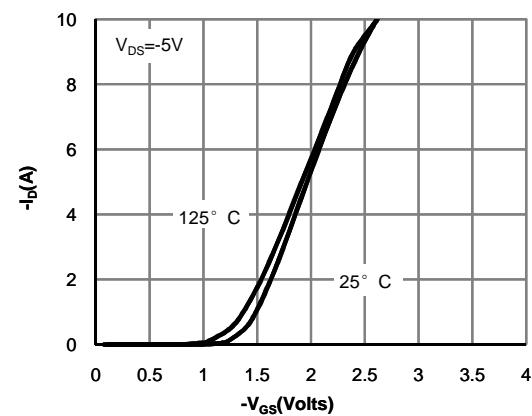
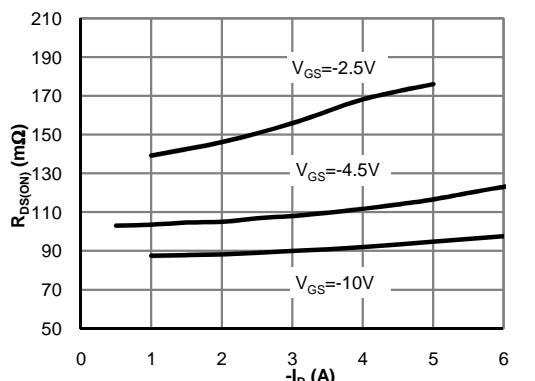
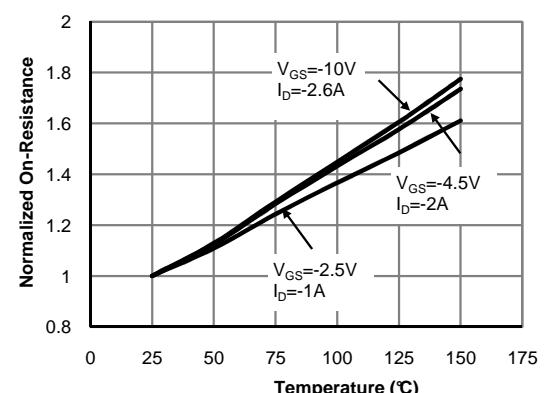
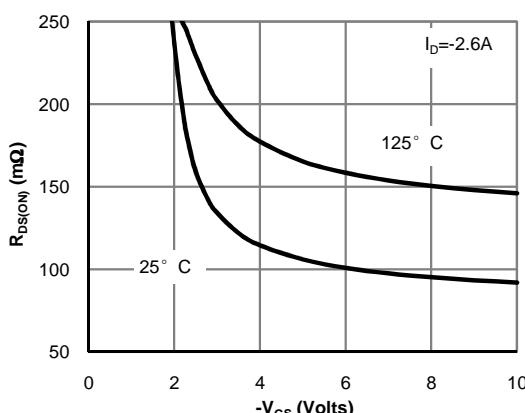
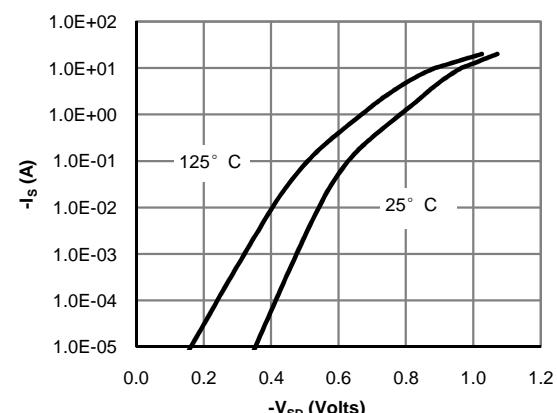
• Static Electrical Characteristics @ $T_J = 25^\circ C$ (unless otherwise stated)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	V_{DSS}	$V_{GS}=0V I_D=-250\mu A$	-30	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-30V V_{GS}=0V$	--	--	-1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{GS}=\pm 12V V_{DS}=0V$	--	--	± 100	nA
On Characteristics <small>(Note 3)</small>						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS} I_D=-250\mu A$	-0.5	-0.8	-1.2	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=-10V I_D=-2.6A$	--	88	115	$m\Omega$
		$V_{GS}=-4.5V I_D=-2A$	--	103	150	$m\Omega$
Dynamic Characteristics <small>(Note 4)</small>						
Input Capacitance	C_{iss}	$V_{DS}=-15V V_{GS}=0V$ $F=1.0MHz$	--	260	--	PF
Output Capacitance	C_{oss}		--	37	--	PF
Reverse Transfer Capacitance	C_{rss}		--	20	--	PF
Switching Characteristics <small>(Note 4)</small>						
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=-15V I_D=-2A$ $V_{GS}=-10V R_G=3.3\Omega$	--	6	--	nS
Turn-on Rise Time	t_r		--	3.5	--	nS
Turn-Off Delay Time	$t_{d(off)}$		--	20	--	nS
Turn-Off Fall Time	t_f		--	5	--	nS
Total Gate Charge	Q_g	$V_{DS}=-15V I_D=-2.6A$ $V_{GS}=-10V$	--	5.9	--	nC
Gate-Source Charge	Q_{gs}		--	0.7	--	nC
Gate-Drain Charge	Q_{gd}		--	1	--	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage <small>(Note 3)</small>	V_{SD}	$V_{GS}=0V I_S=-1A$	--	-0.78	-1	V
Diode Forward Current <small>(Note 2)</small>	I_S		--	--	-1.5	A

Notes:

- A. The value of R_{0JA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ C$. The value in any given application depends on the user's specific board design.
- B. The power dissipation P_D is based on $T_{J(MAX)}=150^\circ C$, using $\leq 10s$ junction-to-ambient thermal resistance.
- C. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}=150^\circ C$. Ratings are based on low frequency and duty cycles to keep initial $T_J=25^\circ C$.
- D. The R_{0JA} is the sum of the thermal impedance from junction to lead R_{0JL} and lead to ambient.
- E. The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.
- F. These curves are based on the junction-to-ambient thermal impedance which is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, assuming a maximum junction temperature of $T_{J(MAX)}=150^\circ C$. The SOA curve provides a single pulse rating.

• Typical Characteristics


Fig 1: On-Region Characteristics (Note E)

Figure 2: Transfer Characteristics (Note E)

Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

Figure 4: On-Resistance vs. Junction Temperature (Note E)

Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

Figure 6: Body-Diode Characteristics (Note E)

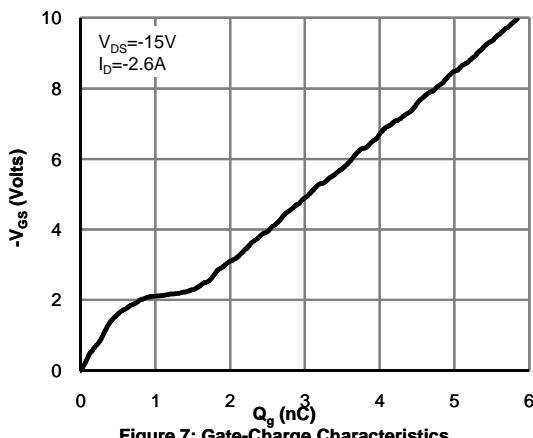


Figure 7: Gate-Charge Characteristics

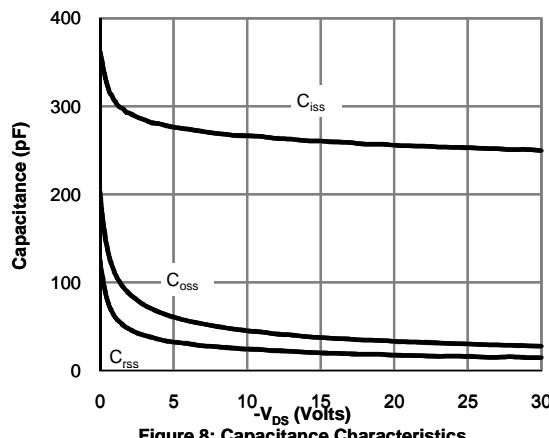


Figure 8: Capacitance Characteristics

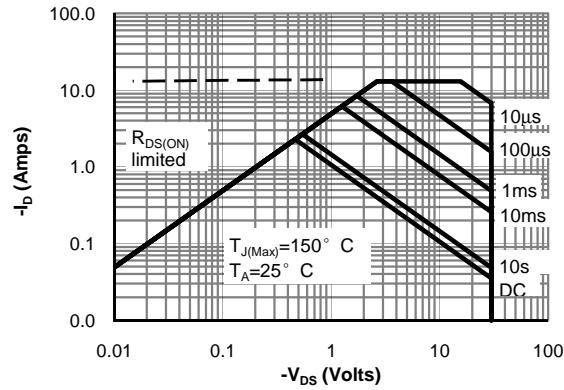


Figure 9: Maximum Forward Biased Safe Operating Area (Note F)

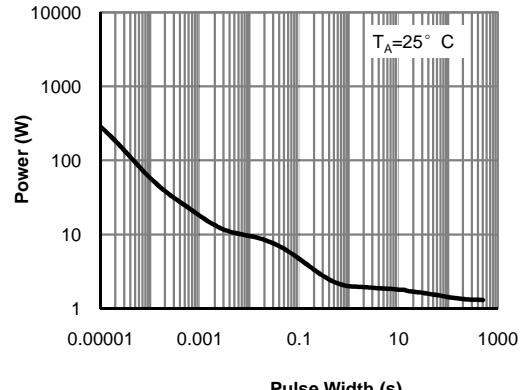


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note F)

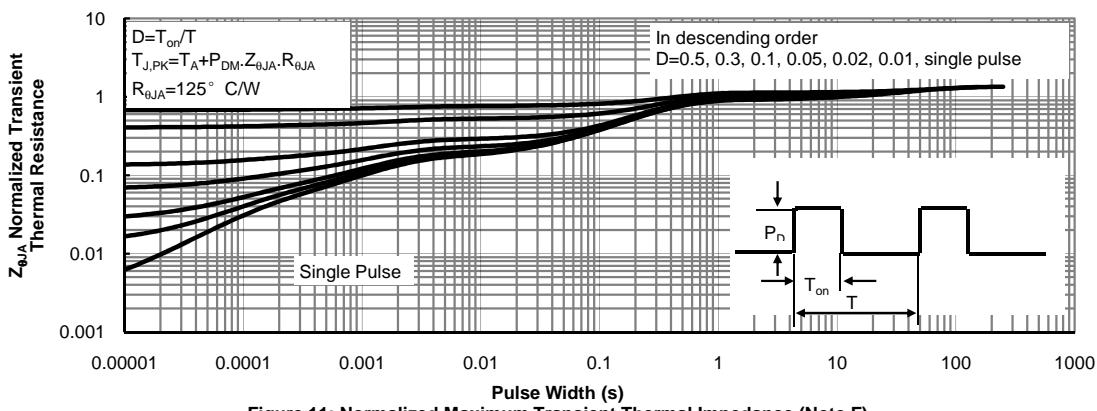
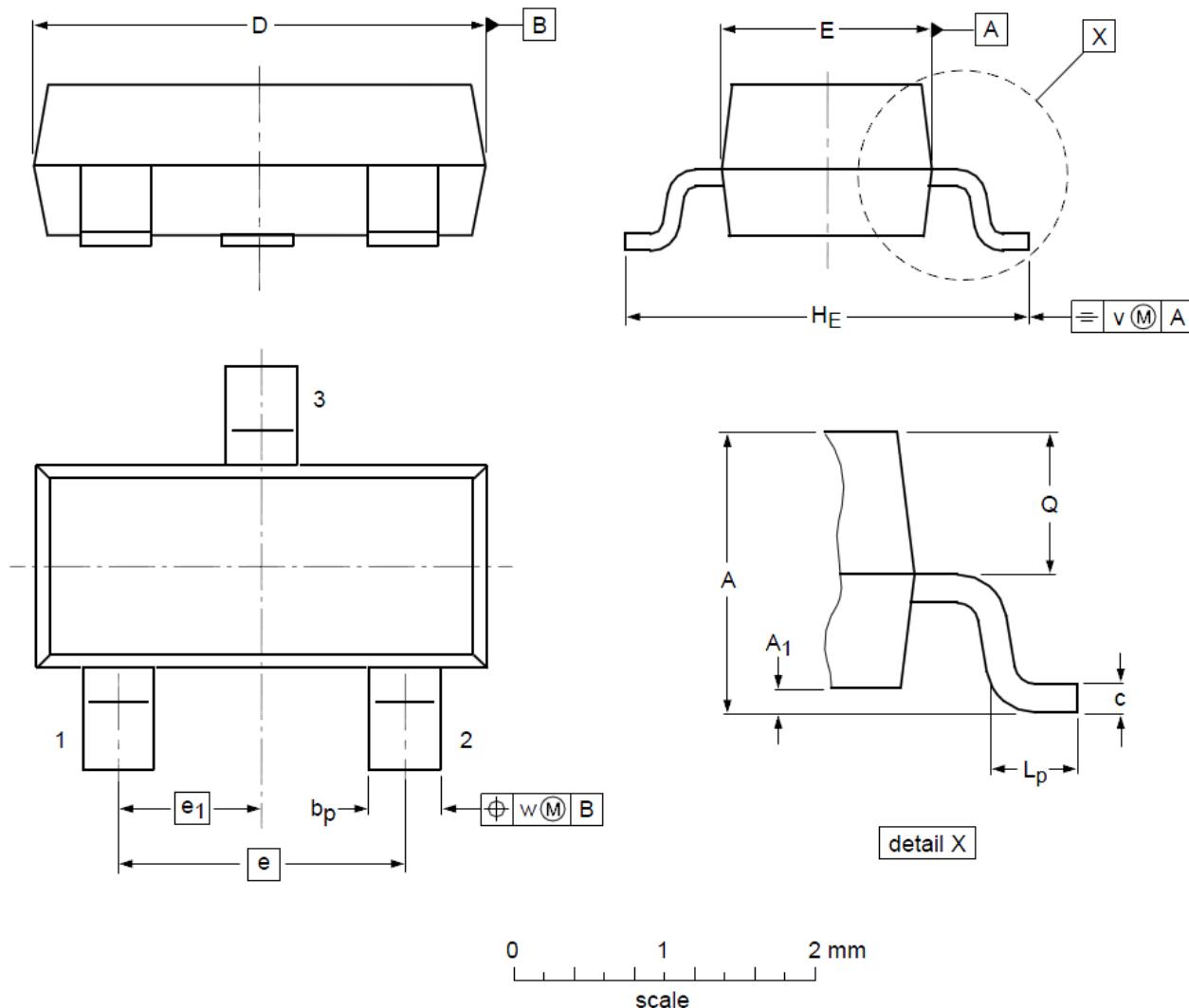


Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

SOT23-3L Package Outline Dimensions

DIMENSIONS (unit : mm)

Symbol	Min	Typ	Max	Symbol	Min	Typ	Max
A	1.00	1.17	1.30	A₁	0.01	0.05	0.10
b_p	0.35	0.39	0.50	c	0.10	0.20	0.26
D	2.70	2.90	3.10	E	1.30	1.58	1.70
e	--	1.90	--	e₁	--	0.95	--
H_E	2.50	2.78	3.00	L_p	0.20	0.32	0.60
Q	0.23	0.27	0.33	v	--	0.20	--
w	--	0.20	--				